



MTS-3268US

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: T. Terada et al.

: Art Unit:

Serial No.: 09/898,338

: Examiner:

Filed: July 3, 2001

FOR: DE-HALOGEN PROCESSING

METHOD OF FIRE-RESISTENT RESIN

COMPOSITE CONTAINING HALOGEN

RECEIVED
TC 1700

INFORMATION DISCLOSURE STATEMENT

Assistant Commissioner for Patents Washington, D.C. 20231

SIR:

Pursuant to 37 C.F.R. §§ 1.97 and 1.98 and to the duty of disclosure set forth in 37 C.F.R. § 1.56, the Examiner in charge of the above-identified application is requested to consider and make of record the references listed on the PTO 1449 (R&P) submitted herewith. A copy of each of the listed references is also enclosed.

Although the information submitted herewith may be "material" to the Examiner's consideration of the subject application, this submission is not intended to constitute an admission that such information is "prior art" as to the claimed invention.

In accordance with 37 C.F.R. § 1.97(g), the filing of this Information Disclosure Statement shall not be construed to mean that a search has been made.

Reference JP 2000-117738 is not in the English language, but a "concise explanation" under 37CFR § 1.98(a)(3) is set forth in the background portion of the specification on page 2.

Reference JP 2000-44966 is not in the English language, but a copy of corresponding U. S. Patent No. 6,162,894 is attached to the copy of the reference submitted herewith.

No first Official Action has yet been received and it is presumed that none has yet been mailed. No fee or certification is required. 37 C.F.R. § 1.97(b).

Respectfully submitted,

Allan Ratner, Reg. No. 19,717 Attorney for Applicants

AR/jam

Enclosures:

PTO Form 1449 Copy of (3) References

Dated: January 31, 2002

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The Assistant Commissioner for Patents is hereby authorized to charge payment to Deposit Account No. 18-0350 of any fees associated with this communication.

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231 on: